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To the Honorable Comm	nissioner of Patents and Tra	demarks: Ple	ease record to	101139547	₃reof.
1. Name of conveying party(ies)			2. Name and	d address of receiving party(ies)	
Eisaburo ITAKURA, Yoichi MATSUMURA, Katsumi TAHARA, Hiroaki SETO		Name:	SONY CORPORATION 7-35 Kitashinagawa 6-chome Shinagawa-Ku, Tokyo 100-31, Japan		
Additional name(s) of conveying party(ies) attached?Yes _XNo			Additional n	name(s) & address(es) attached? Yes	<u>x</u> No
3. Nature of conveyance:					
X Assignment Security Agreement Merger Change of Name Other					
Execution Date(s): August 4, 1999, and August 4, 1	st 16, 1999, August 4, 1999, 999	August			
4. Application number(s) or patent number(s):				
	s document is being filed to plication is:	gether with	a new applica	ation, the execution date of	
A. Patent Applicat	ion No.(s) <u>09/280,430</u> file	ed <u>March 29</u>	, 1999		
	Additional n	umbers atta	ched? Yes	X No	
	Name and address of party to whom correspondence concerning document should be mailed: ame: WILLIAM S. FROMMER		6. Total nu patents	mber of applications and involved	_1_
Name: WILLIA			7. Total fee (37 CFR 3.41)		
Internal Address: FROMMER LAWRENCE & HAUG LLP			X Enclosed Authorized to be charged to		
Street Address: 745 FI	FTH AVENUE	ì		deposit account 50-0320	
City: NEW YO	RK State: <u>N.Y.</u> Zip: <u>10151</u>			account number: icate copy of this page if paying by de	posit
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Box Assignments Washington, D.C. 20231

Public burden reporting for this sample cover sheet is estimated to average about 30 minutes per document to be recorded, including time for reviewing the document and gathering the data needed, and completing and reviewing the sample cover sheet. Send comments regarding this burden estimate to the U.S. Patent and Trademark Office, Office of Information Systems, PK2-1000C, Washington, D.C. 20231, and to the Office of Management and Budget, Paperwork Reduction Project (0651-0011), Washington, D.C. 20503.

FLH File No. 450100-4950

ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

COMMUNICATION APPARATUS WHICH HANDLES A TIME STAMP

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo 141, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 09/280,430, Filing Date: March 29,1999.

This assignment executed on the dates indicated below.

Eisaburo ITAKURA			
Name of first or sole inventor	Execution date of U.S. Patent Application		
Kanagawa, Japan			
Residence of first or sole inventor Walnun Itahun	Aug 16, 1999		
Signature of first or sole inventor	Date of this assignment		
Yoichi MATSUMURA			
Name of second inventor	Execution date of U.S. Patent Application		
Kanagawa, Japan			
Residence of second inventor Matrimura	Aug 4, 1999		
Signature of second inventor	Date of this assignment		
Katsumi TAHARA			
Name of third inventor	Execution date of U.S. Patent Application		
Kanagawa, Japan			
Residence of third inventor Juhana.	Aug 4. 1999		
Signature of third inventor	Date of this assignment		

S99P0725US00

ADDITIONAL INVENTORS

FLH File No. 450100-4950

Signature: Viroiki Soto
Full name of 4th joint inventor (if any):
Residence:
Citizenship:

Hiroaki SETO Kanagawa, Japan Japan

RECORDED: 09/07/1999